

# ASSP

# Single Serial Input PLL Frequency Synthesizer

## On-Chip 2.0 GHz Prescaler

## MB15E05L

### ■ DESCRIPTION

The Fujitsu MB15E05L is serial input Phase Locked Loop (PLL) frequency synthesizer with a 2.0 GHz prescaler. A 64/65 or a 128/129 can be selected for the prescaler that enables pulse swallow operation.

The latest BiCMOS process technology is used, resultantly a supply current is limited as low as 4.0 mA typ. This operates with a supply voltage of 3.0 V (typ.)

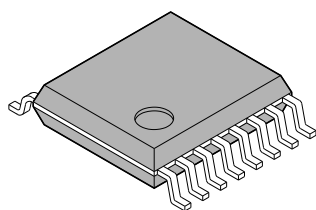
Furthermore, a super charger circuit is included to get a fast tuning as well as low noise performance. As a result of this, MB15E05L is ideally suitable for digital mobile communications, such as DCS 1800 and PCS 1900.

### ■ FEATURES

- High frequency operation: 2.0 GHz max.
- Low power supply voltage:  $V_{CC} = 2.7$  to 3.6 V
- Very Low power supply current :  $I_{CC} = 4.0$  mA typ. ( $V_{CC} = 3$  V)
- Power saving function :  $I_{PS} = 0.1$   $\mu$ A typ. ( $V_{CC} = 3$  V)
- Pulse swallow function: 64/65 or 128/129
- Serial input 14-bit programmable reference divider:  $R = 5$  to 16,383
- Serial input 18-bit programmable divider consisting of:
  - Binary 7-bit swallow counter: 0 to 127
  - Binary 11-bit programmable counter: 5 to 2,047
- On-chip high performance charge pump circuit and phase comparator, achieving high-speed lock-up and low phase noise.
- Wide operating temperature:  $T_a = -40$  to 85°C
- Plastic 16-pin SSOP package (FPT-16P-M05) and 16-pin BCC package (LCC-16P-M02)

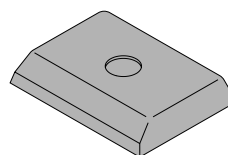
### ■ PACKAGES

16-pin, Plastic SSOP



(FPT-16P-M05)

16-pin, Plastic BCC

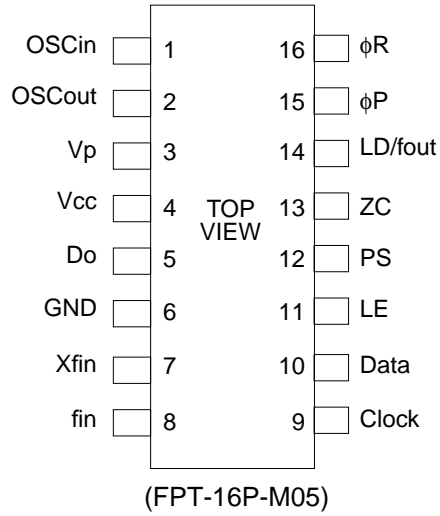


(LCC-16P-M02)

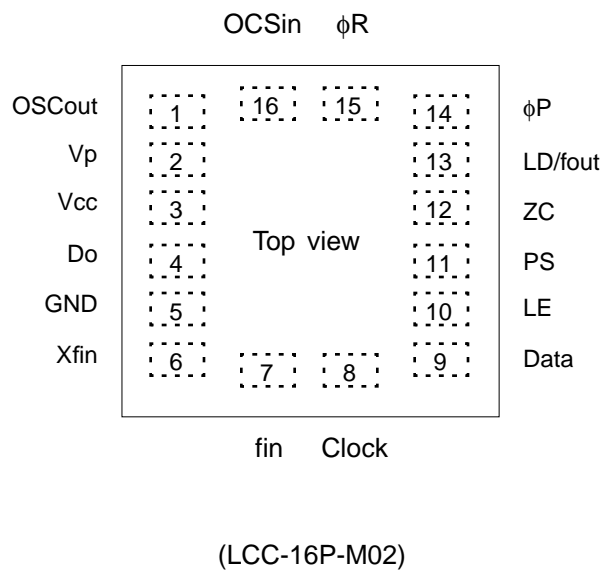
# MB15E05L

## ■ PIN ASSIGNMENTS

### SSOP-16 pin



### BCC-16 pin

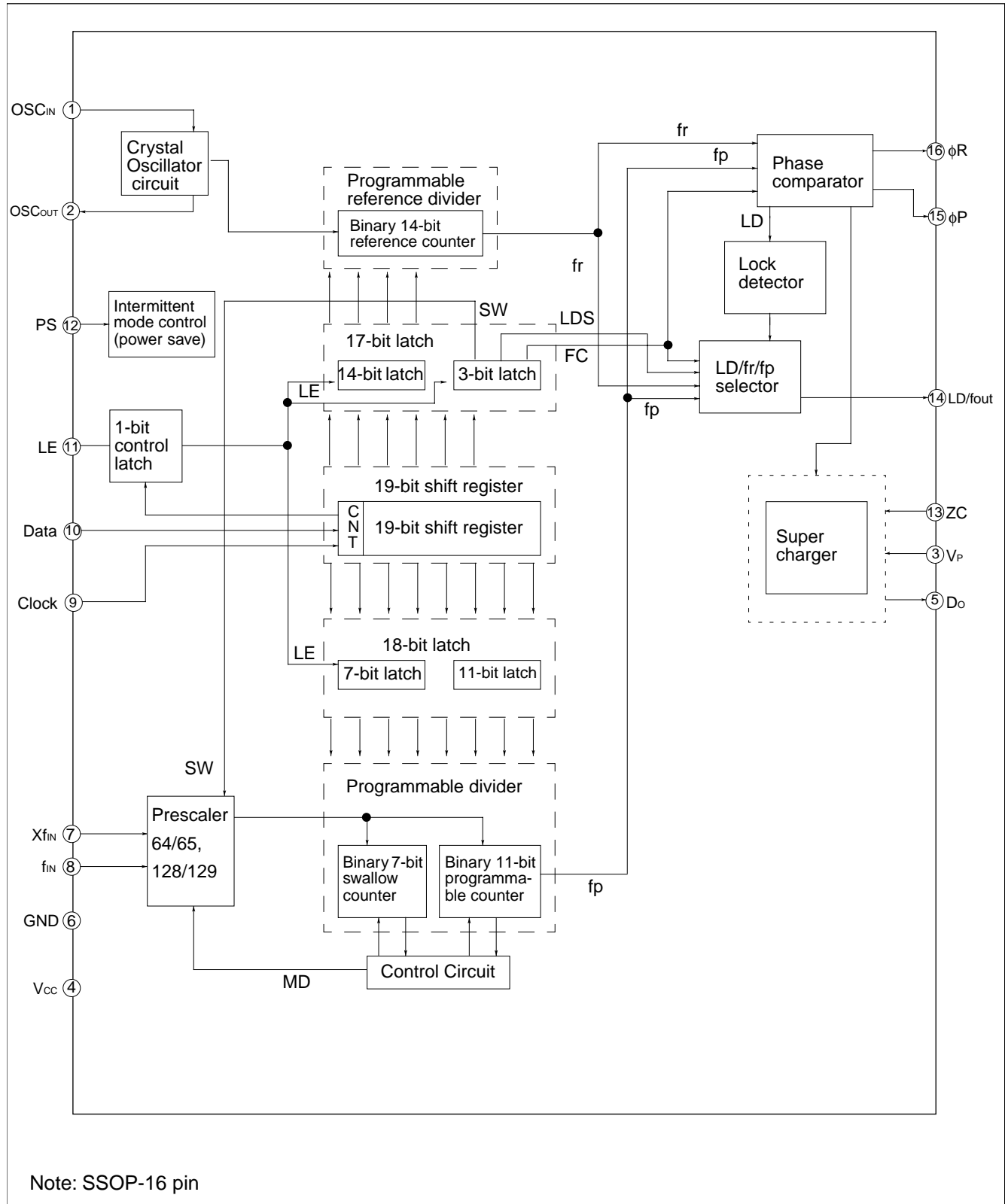


## ■ PIN DESCRIPTIONS

Pin no.		Pin name	I/O	Descriptions
SSOP	BCC			
1	16	OSC <sub>IN</sub>	I	Programmable reference divider input. Oscillator input. Connection for an crystal or a TCXO. TCXO should be connected with a coupling capacitor.
2	1	OSC <sub>OUT</sub>	O	Oscillator output. Connection for an external crystal.
3	2	V <sub>P</sub>	–	Power supply voltage input for the charge pump.
4	3	V <sub>CC</sub>	–	Power supply voltage input.
5	4	D <sub>o</sub>	O	Charge pump output. Phase of the charge pump can be reversed by FC bit.
6	5	GND	–	Ground.
7	6	Xfin	I	Prescaler complementary input, and should be grounded via a capacitor.
8	7	fin	I	Prescaler input. Connection with an external VCO should be done with AC coupling.
9	8	Clock	I	Clock input for the 19-bit shift register. Data is shifted into the shift register on the rising edge of the clock. ( <i>Open is prohibited.</i> )
10	9	Data	I	Serial data input using binary code. The last bit of the data is a control bit. ( <i>Open is prohibited.</i> ) Control bit = "H"; Data is transmitted to the programmable reference counter. Control bit = "L"; Data is transmitted to the programmable counter.
11	10	LE	I	Load enable signal input ( <i>Open is prohibited.</i> ) When LE is high, the data in the shift register is transferred to a latch, according to the control bit in the serial data.
12	11	PS	I	Power saving mode control. This pin must be set at "L" at Power-ON. ( <i>Open is prohibited.</i> ) PS = "H"; Normal mode PS = "L"; Power saving mode
13	12	ZC	I	Forced high-impedance control for the charge pump (with internal pull up resistor.) ZC = "H"; Normal D <sub>o</sub> output. ZC = "L"; D <sub>o</sub> becomes high impedance.
14	13	LD/fout	O	Lock detect signal output(LD)/phase comparator monitoring output (fout). The output signal is selected by LDS bit in the serial data. LDS = "H"; outputs fout (fr/fp monitoring output) LDS = "L"; outputs LD ("H" at locking, "L" at unlocking.)
15	14	φP	O	Phase comparator output for an external charge pump. Nch open drain output.
16	15	φR	O	Phase comparator output for an external charge pump. CMOS output.

# MB15E05L

## ■ BLOCK DIAGRAM



## ■ ABSOLUTE MAXIMUM RATINGS (See WARNING)

Parameter	Symbol	Rating		Unit	Remark
		Min.	Max.		
Power supply voltage	V <sub>CC</sub>	-0.5	+4.0	V	
	V <sub>P</sub>	V <sub>CC</sub>	+6.0	V	
Input voltage	V <sub>I</sub>	-0.5	V <sub>CC</sub> +0.5	V	
Output voltage	V <sub>O</sub>	-0.5	V <sub>CC</sub> +0.5	V	
Output current	I <sub>O</sub>	-10	+10	mA	Except Do output
	I <sub>do</sub>	-25	+25	mA	Do output
Open drain voltage	V <sub>ooP</sub>	-0.5	7.0	V	
Storage temperature	T <sub>stg</sub>	-55	+125	°C	

**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value			Unit	Remark
		Min.	Typ.	Max.		
Power supply voltage	V <sub>CC</sub>	2.7	3.0	3.6	V	
	V <sub>P</sub>	V <sub>CC</sub>	-	6.0	V	
Input voltage	V <sub>I</sub>	GND	-	V <sub>CC</sub>	V	
Operating temperature	T <sub>a</sub>	-40	-	+85	°C	

**WARNING:** Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

## Handling Precautions

- This device should be transported and stored in anti-static containers.
- This is a static-sensitive device; take proper anti-ESD precautions. Ensure that personnel and equipment are properly grounded. Cover workbenches with grounded conductive mats.
- Always turn the power supply off before inserting or removing the device from its socket.
- Protect leads with a conductive sheet when handling or transporting PC boards with devices.

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## ■ ELECTRICAL CHARACTERISTICS

( $V_{CC} = 2.7$  to  $3.6$  V,  $T_a = -40$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Condition	Value			Unit	
			Min.	Typ.	Max.		
Power supply current*1	$I_{CC}^{*1}$	$f_{in} = 2000$ MHz, $f_{osc} = 12$ MHz	–	4.0	–	mA	
Power saving current	$I_{PS}^{*2}$	ZC = “H” PS = “L”	–	0.1	10	$\mu\text{A}$	
Operating frequency	$f_{in}^{*3}$	–	100	–	2000	MHz	
Crystal oscillator operating frequency	$f_{osc}$	–	3	–	40	MHz	
Input sensitivity	$f_{in}$	$V_{fin}$	50 $\Omega$ system (Refer to the test circuit.)	–10	–	+2	dBm
	OSCin*3	$V_{osc}$	–	0.5	–	$V_{CC}$	Vp-p
Input voltage	Data, Clock, LE, PS, ZC	$V_{IH}$	–	$V_{CC} \times 0.7$	–	–	V
		$V_{IL}$	–	–	–	$V_{CC} \times 0.3$	
Input current	Data, Clock, LE, PS	$I_{IH}^{*4}$	–	–1.0	–	+1.0	$\mu\text{A}$
		$I_{IL}^{*4}$	–	–1.0	–	+1.0	
	ZC	$I_{IH}^{*4}$	–	–1.0	–	+1.0	$\mu\text{A}$
		$I_{IL}^{*4}$	Pull up input	–100	–	0	
	OSCin	$I_{IH}$	–	0	–	+100	$\mu\text{A}$
		$I_{IL}^{*4}$	–	–100	–	0	
Output voltage	$\phi P$	$V_{OL}$	Open drain output	–	–	0.4	V
	$\phi R$ , LD/fout	$V_{OH}$	$V_{CC} = 3$ V, $I_{OH} = -1$ mA	$V_{CC} - 0.4$	–	–	V
		$V_{OL}$	$V_{CC} = 3$ V, $I_{OL} = 1$ mA	–	–	0.4	
	Do	$V_{DOH}$	$V_{CC} = 3$ V, $I_{OH} = -1$ mA	$V_P - 0.4$	–	–	V
$V_{DOL}$		$V_{CC} = 3$ V, $I_{OL} = 1$ mA	–	–	0.4		
High impedance cutoff current	Do	$I_{OFF}$	$V_{CC} = 3$ V, $V_p = 6$ V $V_{OOP} = \text{GND to } 6$ V	–	–	3.0	nA
Output current	$\phi P$	$I_{OL}$	Open drain output	1.0	–	–	mA
	$\phi R$ , LD/fout	$I_{OH}^{*4}$	–	–1.0	–	–	mA
		$I_{OL}$	–	–	–	1.0	
	Do	$I_{DOH}^{*4,5}$	$V_{CC} = V_p = 3$ V, $V_{DOH} = 2.0$ V,	–11	–	–6	mA
$I_{DOL}^{*5}$		$V_{CC} = V_p = 3$ V $V_{DOL} = 1.0$ V	8	–	15		

\*1: Conditions;  $V_{CC} = 3.0$  V,  $T_a = 25^\circ\text{C}$ , in locking state.

\*2:  $V_{CC} = 3.0$  V,  $f_{osc} = 12.8$  MHz,  $T_a = 25^\circ\text{C}$ , in power saving state.

\*3: AC coupling with a 1000pF capacitor connected.

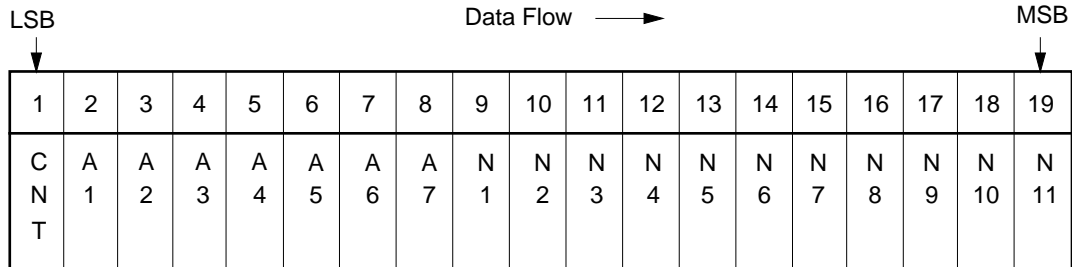
\*4: The symbol “–” (minus) means direction of current flow.

\*5:  $T_a = +25^\circ\text{C}$



# MB15E05L

## Programmable Reference Counter



CNT : Control bit [Table. 1]  
 N1 to N11 : Divide ratio setting bits for the programmable counter (5 to 2,047) [Table. 3]  
 A1 to A7 : Divide ratio setting bits for the swallow counter (0 to 127) [Table. 4]

Note: Start data input with MSB first

**Table2. Binary 14-bit Programmable Reference Counter Data Setting (R1 to R14)**

Divide ratio (R)	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1
5	0	0	0	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	0	0	0	1	1	0
.	.	.	.	.	.	.	.	.	.	.	.	.	.	.
16383	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

**Table.3 Binary 11-bit Programmable Counter Data Setting (N1 to N11)**

Divide ratio (N)	N11	N10	N9	N8	N7	N6	N5	N4	N3	N2	N1
5	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	1	1	0
.	.	.	.	.	.	.	.	.	.	.	.
2047	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.  
 • Divide ratio (N) range = 5 to 2,047

**Table.4 Binary 7-bit Swallow Counter Data Setting**

Divide ratio (A)	A 7	A 6	A 5	A 4	A 3	A 2	A 1
0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	1
.	.	.	.	.	.	.	.
127	1	1	1	1	1	1	1

Note: • Divide ratio (A) range = 0 to 127

**Table. 5 Prescaler Data Setting**

SW	Prescaler Divide ratio
H	64/64
L	128/129

**Table. 6 LD/fout Output Select Data Setting**

LDS	LD/fout output signal
H	fout signal
L	LD signal

**Relation between the FC input and phase characteristics**

The FC bit changes the phase characteristics of the phase comparator. Both the internal charge pump output level ( $D_o$ ) and the phase comparator output ( $\phi_R$ ,  $\phi_P$ ) are reversed according to the FC bit. Also, the monitor pin ( $f_{OUT}$ ) output is controlled by the FC bit. The relationship between the FC bit and each of  $D_o$ ,  $\phi_R$ , and  $\phi_P$  is shown below.

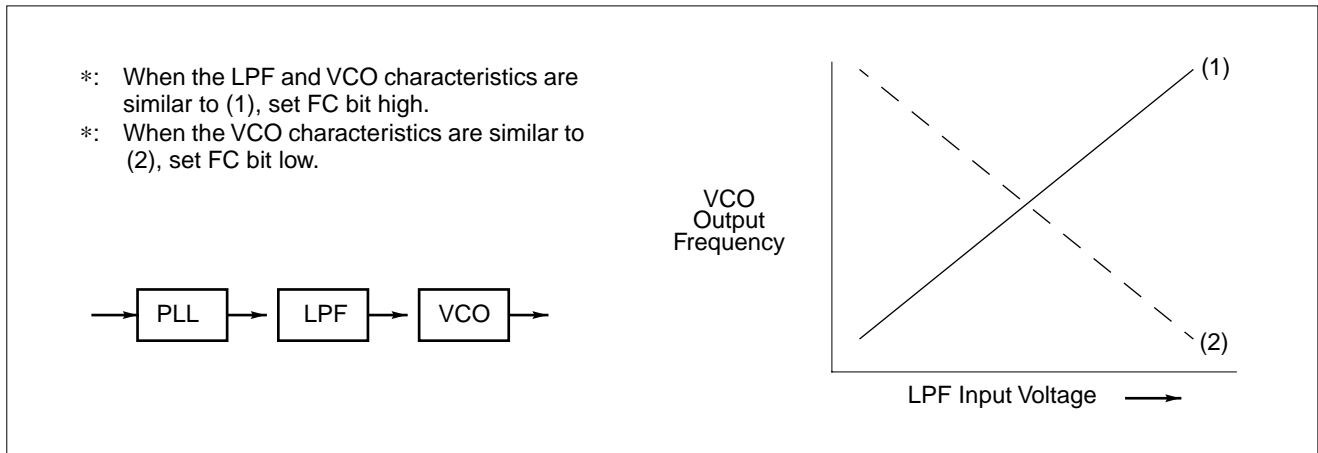
**Table. 7 FC Bit Data Setting (LDS = "H")**

	FC = High				FC = Low			
	$D_o$	$\phi_R$	$\phi_P$	LD/fout	$D_o$	$\phi_R$	$\phi_P$	LD/fout
$f_r > f_p$	H	L	L	$f_{out}=f_r$	L	H	Z*	$f_{out}=f_p$
$f_r < f_p$	L	H	Z*		H	L	L	
$f_r = f_p$	Z*	L	Z*		Z*	L	Z*	

\* : High impedance

# MB15E05L

When designing a synthesizer, the FC pin setting depends on the VCO and LPF characteristics.



**Table.8 PS Pin Setting**

PS pin	Status
H	Normal mode
L	Power saving mode

**Table.9 ZC Pin Setting**

ZC pin	Do output
H	Normal output
L	High impedance

### 3. Power Saving Mode (Intermittent Mode Control Circuit)

Setting a PS pin to Low, the IC enters into power saving mode resultantly current consumption can be limited to 10  $\mu$ A (max.). Setting PS pin to High, power saving mode is released so that the IC works normally.

In addition, the intermittent operation control circuit is included which helps smooth start up from the power saving mode. In general, the power consumption can be saved by the intermittent operation that powering down or waking up the synthesizer. Such case, if the PLL is powered up uncontrolled, the resulting phase comparator output signal is unpredictable due to an undefined phase relation between reference frequency ( $f_r$ ) and comparison frequency ( $f_p$ ) and may in the worst case take longer time for lock up of the loop.

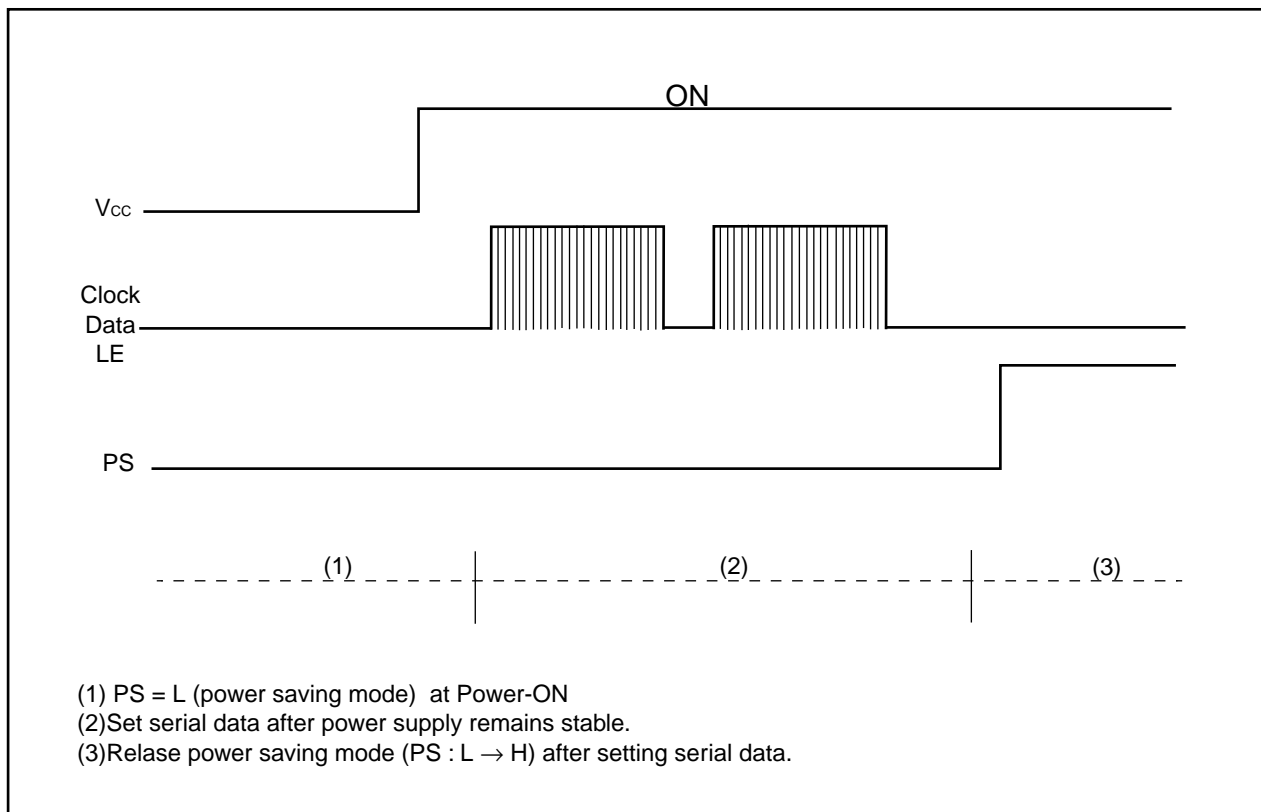
To prevent this, the intermittent operation control circuit enforces a limited error signal output of the phase detector during power up, thus keeping the loop locked.

During the power saving mode, the corresponding section except for indispensable circuit for the power saving function stops working, then current consumption is reduced to 10  $\mu$ A (max.).

At that time, the Do and LD become the same state as when a loop is locking. That is, the Do becomes high impedance.

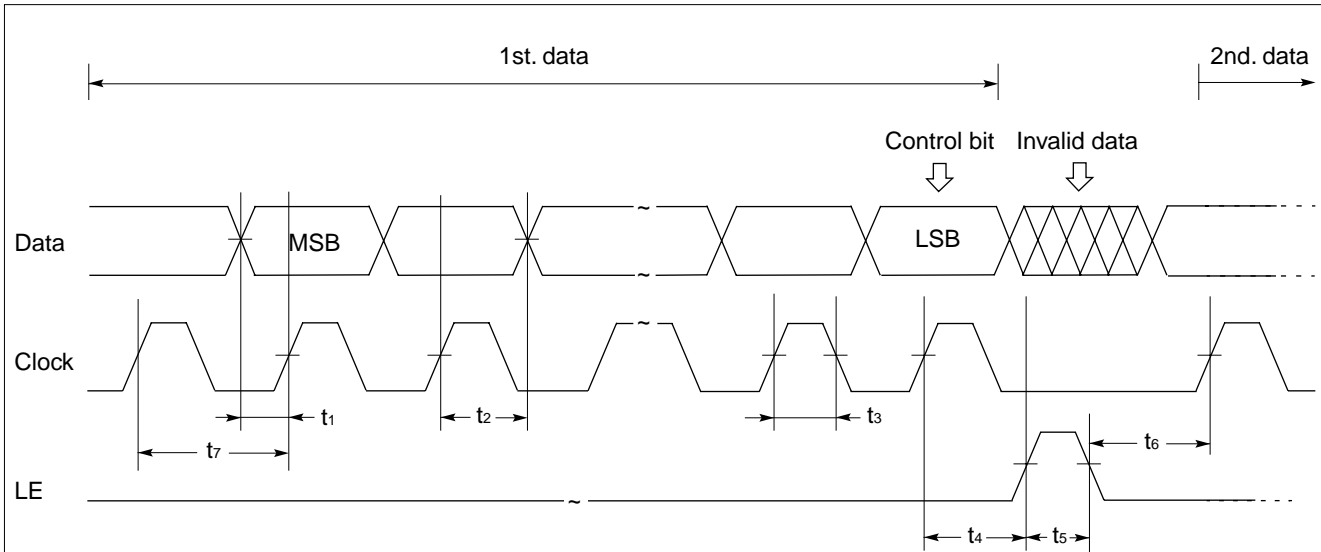
A VCO control voltage is naturally kept at the locking voltage which defined by a LPF's time constant. As a result of this, VCO's frequency is kept at the locking frequency.

- Note:
- While the power saving mode is executed, ZC pin should be set at "H" or open. If ZC is set at "L" during power saving mode, approximately 10  $\mu$ A current flows.
  - PS pin must be set "L" at Power-ON.
  - The power saving mode can be released (PS : L  $\rightarrow$  H) 1 $\mu$ s later after power supply remains stable.
  - During the power saving mode, it is possible to input the serial data.



# MB15E05L

## 4. Serial Data Input Timing

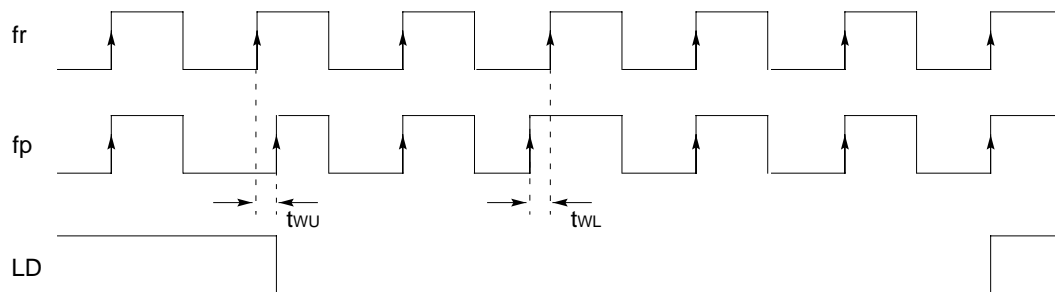


On rising edge of the clock, one bit of the data is transferred into the shift register.

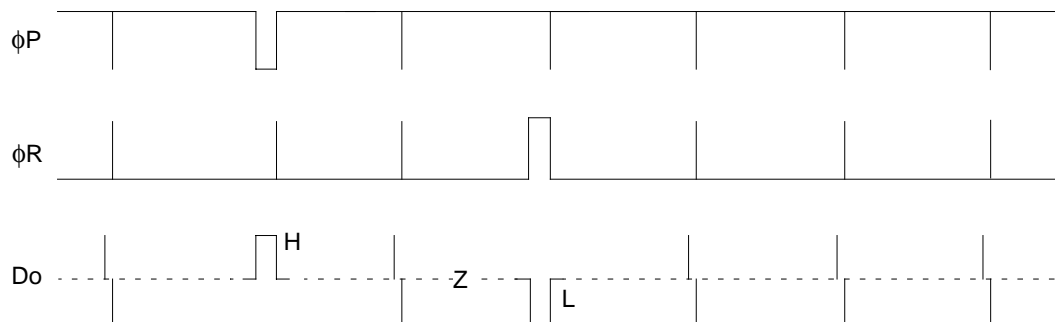
Parameter	Min.	Typ.	Max.	Unit
t1	20	–	–	ns
t2	20	–	–	ns
t3	30	–	–	ns
t4	30	–	–	ns

Parameter	Min.	Typ.	Max.	Unit
t5	100	–	–	ns
t6	20	–	–	ns
t7	100	–	–	ns

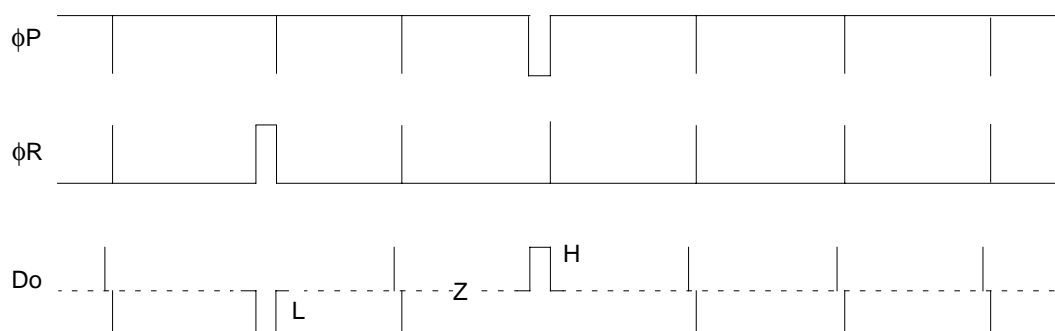
## ■ PHASE COMPARATOR OUTPUT WAVEFORM



[ FC = "H" ]



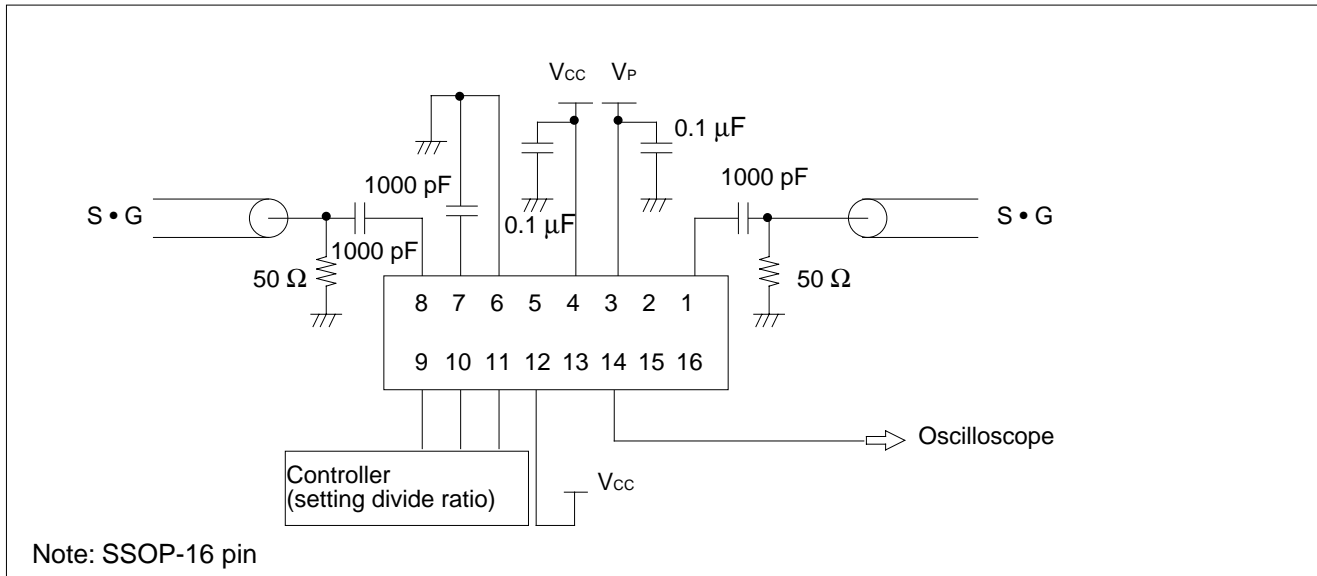
[ FC = "L" ]



- Notes:
1. Phase error detection range:  $-2\pi$  to  $+2\pi$
  2. Pulses on Do output signal during locked state are output to prevent dead zone.
  3. LD output becomes low when phase is  $t_{wu}$  or more. LD output becomes high when phase error is  $t_{wl}$  or less and continues to be so for three cycles or more.
  4.  $t_{wu}$  and  $t_{wl}$  depend on OSCin input frequency.  
 $t_{wu} \geq 4/f_{osc}$  (e. g.  $t_{wu} \geq 312.5\text{ns}$ ,  $f_{osc} = 12.8\text{ MHz}$ )  
 $t_{wl} \leq 8/f_{osc}$  (e. g.  $t_{wl} \leq 625.0\text{ns}$ ,  $f_{osc} = 12.8\text{ MHz}$ )

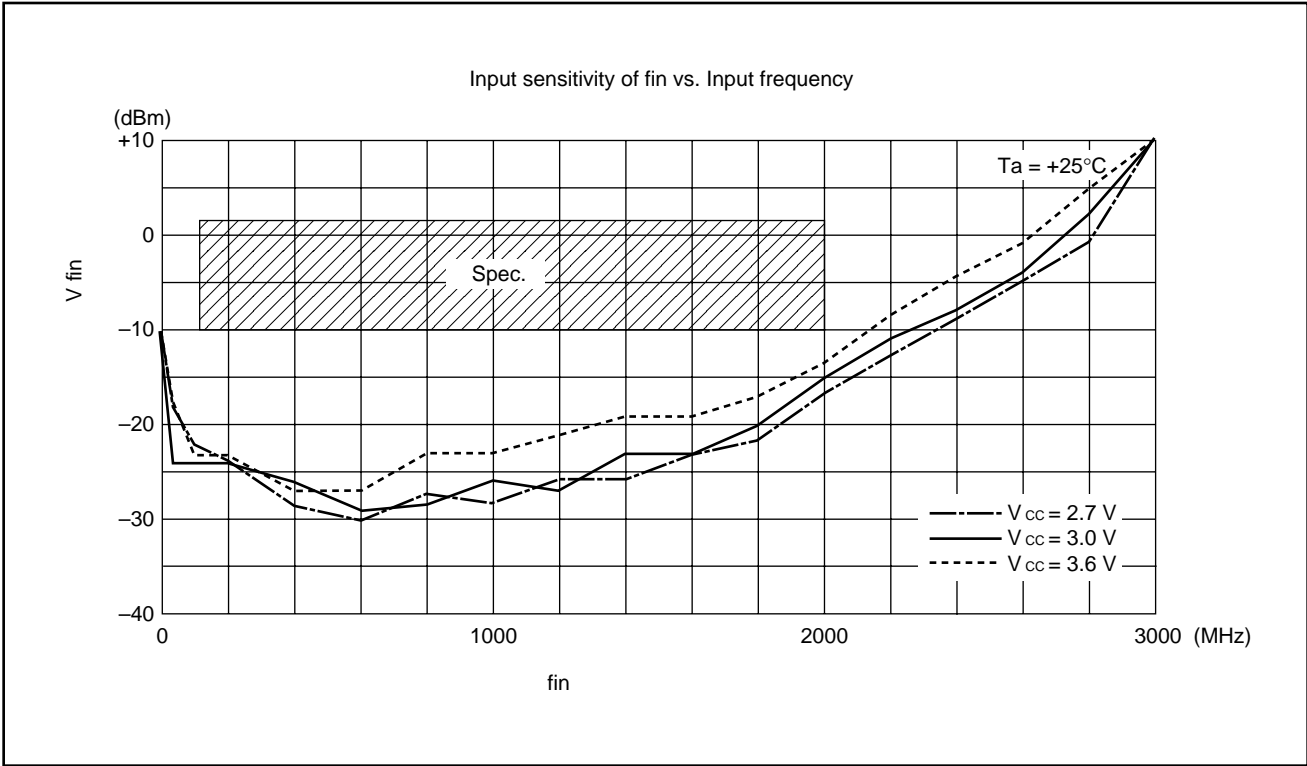
# MB15E05L

## ■ TEST CIRCUIT (for Measuring Input Sensitivity fin/OSCin)

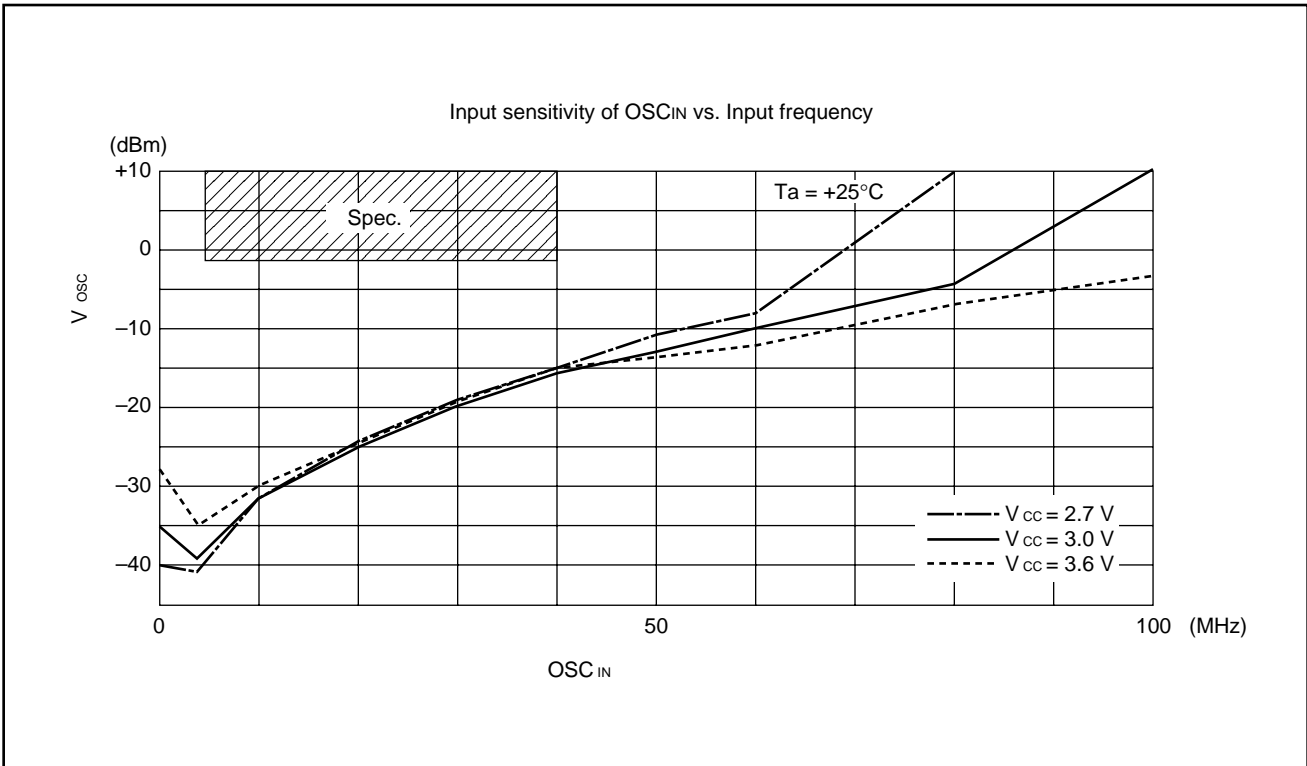


■ TYPICAL CHARACTERISTICS

1. fin Input Sensitivity

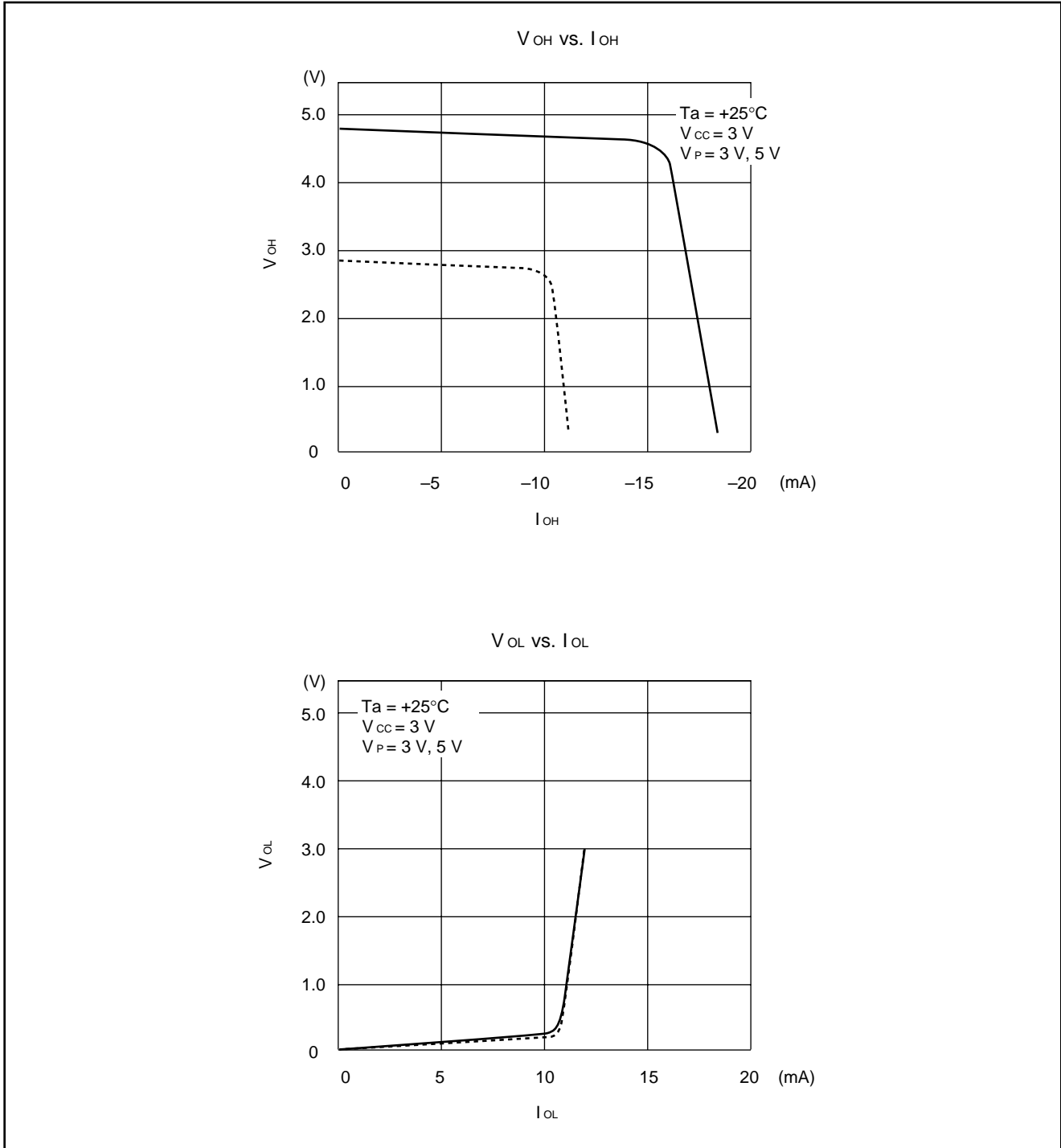


2. OSC<sub>IN</sub> Input Sensitivity

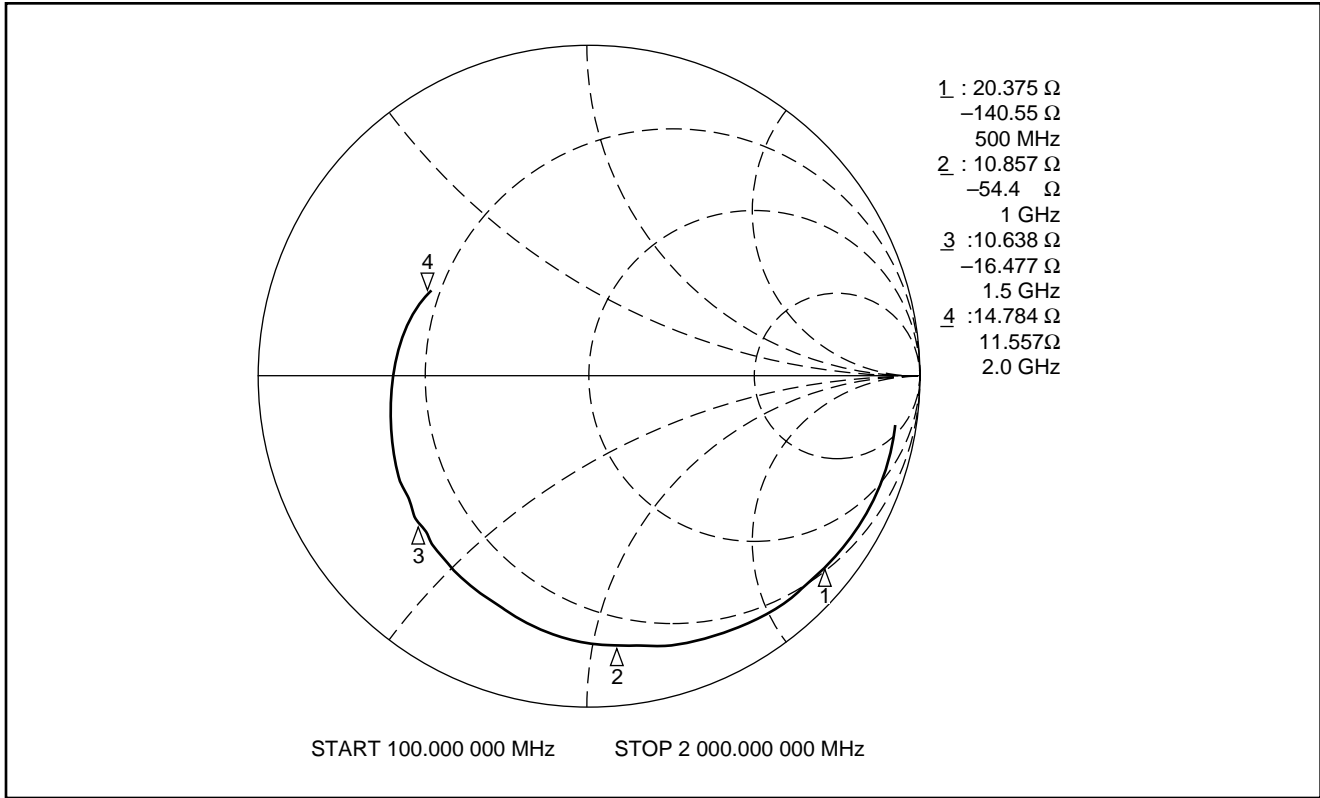


# MB15E05L

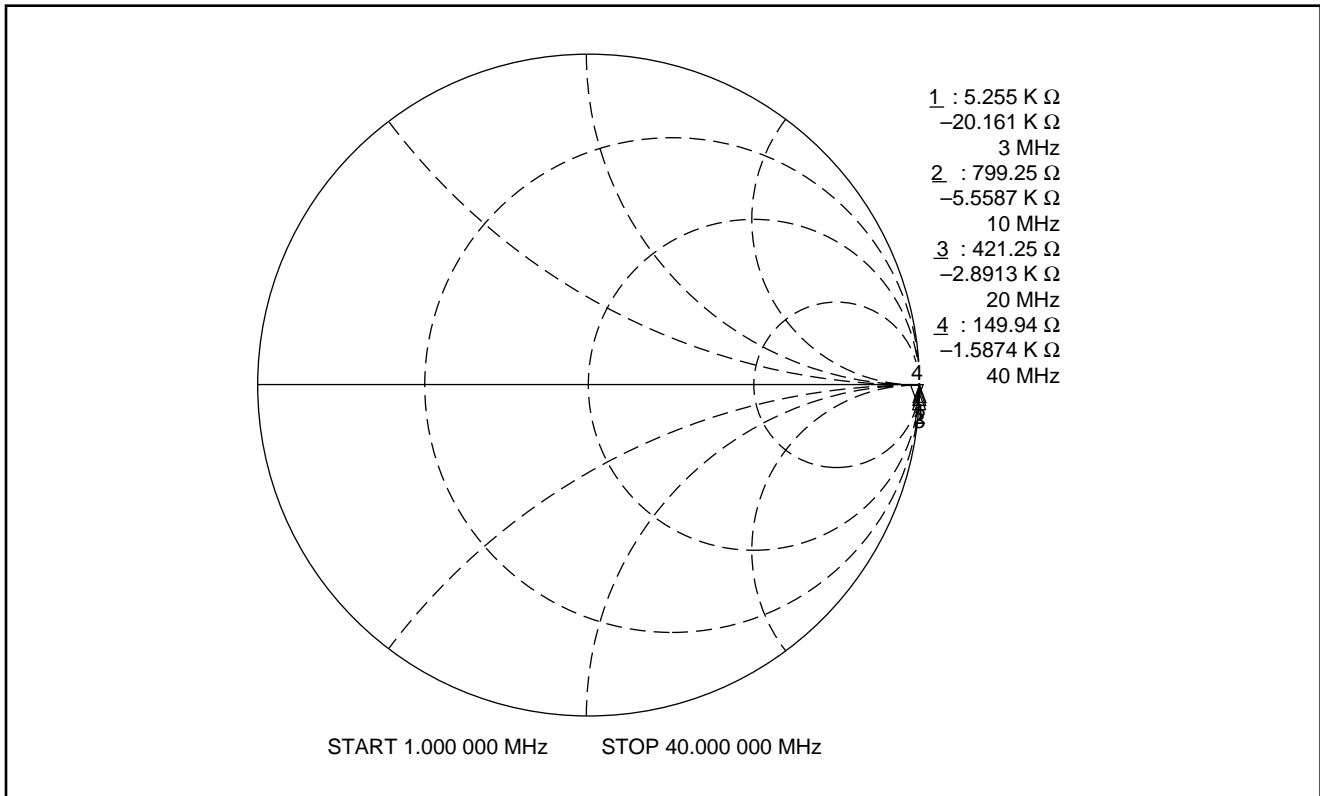
## 3. Do Output Current



## 4. fin Input Impedance

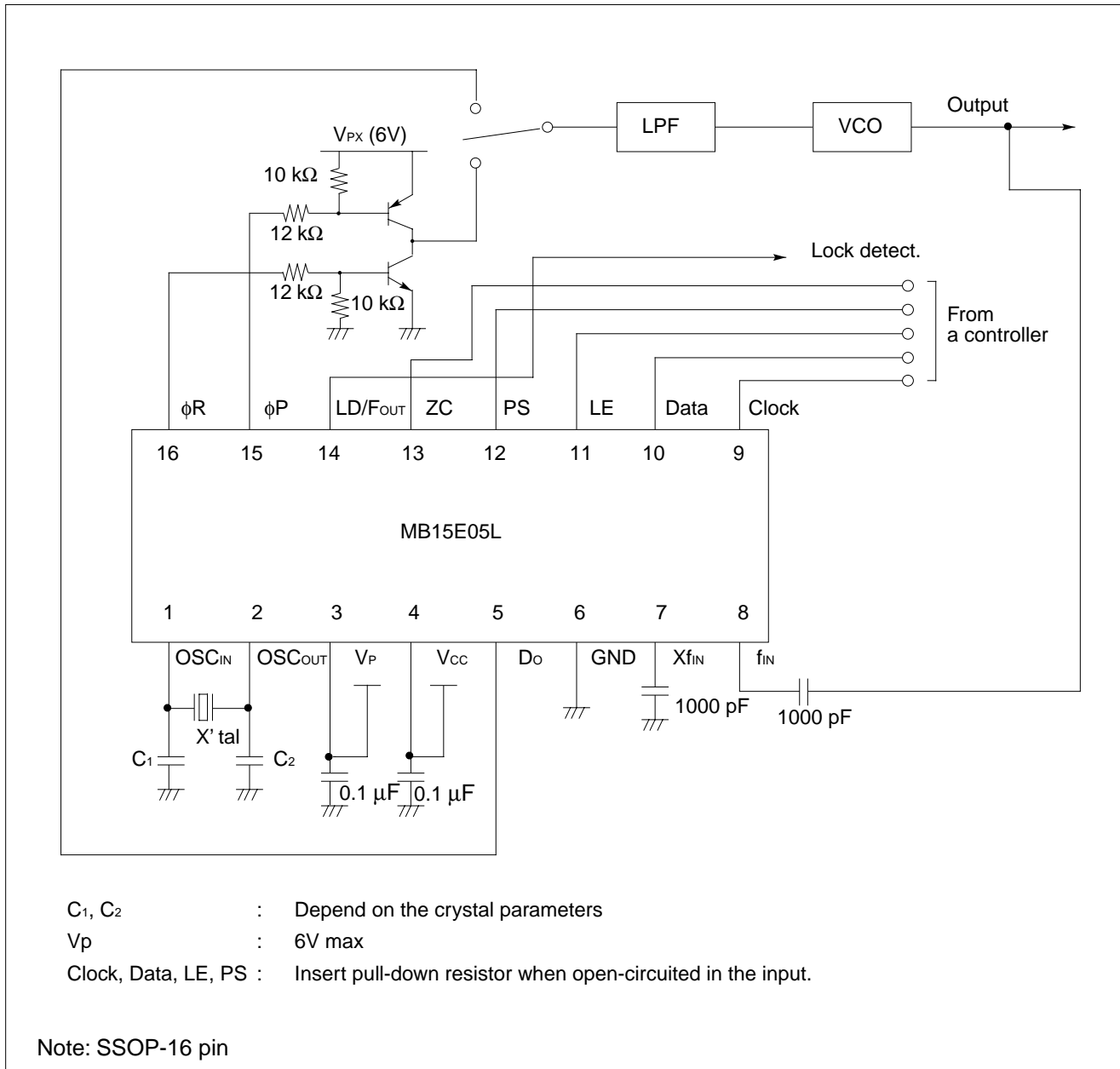


## 5. OSC<sub>IN</sub> Input Impedance



# MB15E05L

## APPLICATION EXAMPLE



# MB15E05L

## ■ ORDERING INFORMATION

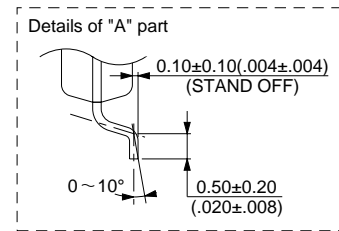
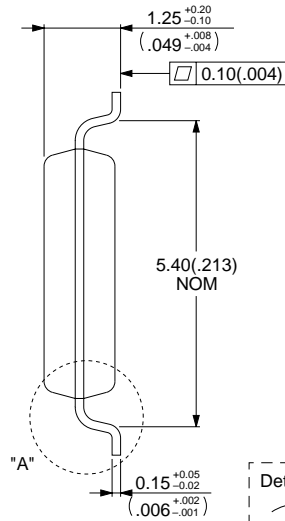
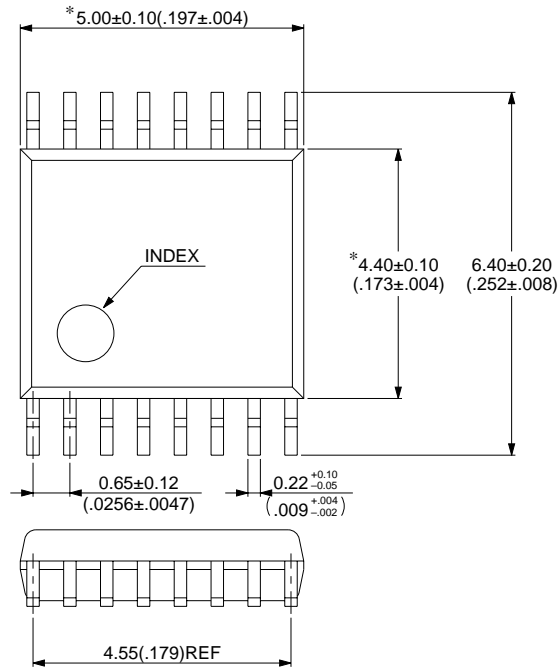
Part number	Package	Remarks
MB15E05PFV1	Plastic SSOP 16 pin (FPT-16P-M05)	
MB15E05LPV	Plastic BCC, 16 pin (LCC-16P-M02)	

# MB15E05L

## ■ PACKAGE DIMENSIONS

16 pins, Plastic SSOP  
(FPT-16P-M05)

\* : These dimensions do not include resin protrusion.



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Dimensions in mm (inches)

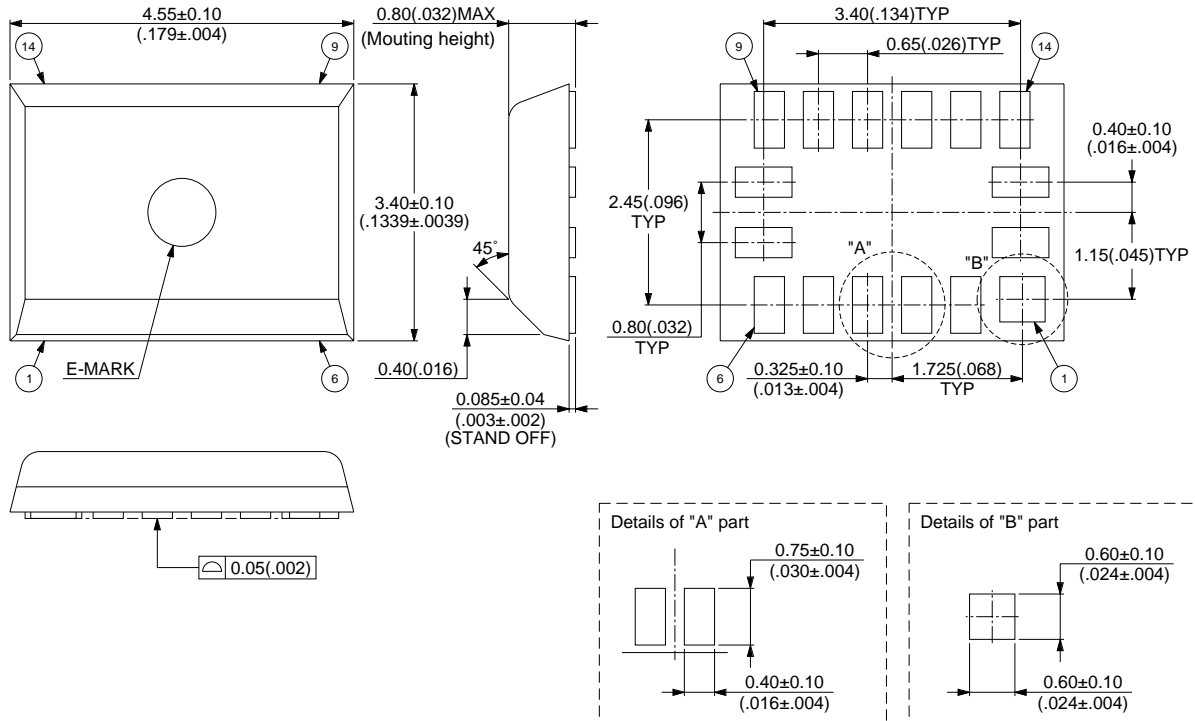
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# MB15E05L

(Continued)

16 pins, Plastic BCC  
(LCC-16P-M02)

\* : These dimensions do not include resin protrusion.



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Dimensions in mm (inches)

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